Band

- 19. (Amended) A film manufacturing method characterized in that a composition according to claim 1 is supplied and distributed on a substrate, and thereafter, this substrate is subjected to heat treatment.
- 22. (Amended) The film manufacturing method according to claim 20 wherein, after high temperature processing, pressure is immediately reduced as-is, and solvent is removed.
- 23. (Amended) The film manufacturing method according to claim 20 wherein said dispensing apparatus is an ink fet printing apparatus.
- 24. (Amended) A functional device characterized by being formed using a composition disclosed in claim 1.

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- 28. (Amended) The functional device according to claim 25 wherein said display device is an organic EL device.
- (Amended) The functional device manufacturing method according to claim
 wherein said heat treatment is performed under applying pressure.
- 33. (Amended) The/functional device manufacturing method according to claim 30 wherein, during said heat treatment, pressure is reduced prior to a composition becoming completely dry.
- 34. (Amended) The functional device manufacturing method according to claim 29 wherein a hold injection/transport layer is formed by an ink jet method on said substrate having a first electrode using a solution comprising a polar solvent, and thereafter, said luminescent material layer pattern is formed on the hole injection/transport layer, whereby an organic EL device is obtained.
- (Amended) The functional device manufacturing method according to claim
 wherein an organic EL device is obtained as said functional device.